

EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	"10598514"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:21
S2	842169	package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:23
S3	1820343	chip die	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:23
S4	159802	S3 near5 (first second)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:25
S5	45456	S2 and S4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:25
S6	32444	S5 and (substrate PCB PWB)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:26
S7	18025	S6 and ((substrate pcb pwb) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:27
S8	10270	S7 and (adhesive or (die near attach))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:28

S9	3818	S8 and ((adhesive or (die near attach)) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:29
S10	1900	S9 and (stack\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:29
S11	371	S10 and ((substrate PCB PWB) near5 (open\$3 window))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:31
S12	189	S11 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:33
S13	35	S12 and (substrate with conductive with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:55
S14	8	S12 and (interpos\$3 with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:22
S15	8	S12 and ((interpos\$3 redistribut\$3) with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:44
S16	1748	((interpos\$3 redistribut\$3) with trace) and package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:48
S17	70	S10 and S16	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:48

S18	31	S17 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:48
S19	293	(interpos\$3 with redistribut \$3) and package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:56
S20	33	S10 and S19	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:57
S21	12	S20 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:57
S22	73	Package and (redistribution with trace) and (stack\$2 with (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:08
S23	369	Package and (redistribution with trace) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:26
S24	296	S23 not S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:26
S25	24	("20020005577" "20020172024" "5291061" "5323060" "5952725" "5998860" "6091140" "6118176" "6258626" "6343019" "6531784" "6650009").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:38
S26	2	("20050239234").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/05 14:30

S27	369	Package and (redistribution with trace) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 14:36
S28	104	11/030998 11/094623 11/181748 10/555054 10/559943 10/565624 11/341464 11/341673 11/276684 11/394263 10/576273 11/430844 11/479373 10/585733 10/585744 11/485334 11/486244 11/487234 10/586543 11/493583 11/494484 11/495653 11/463443 11/463824 11/502094 11/466773 11/513258 11/519754 10/598934 11/521553 11/524244 11/526464 11/526484 10/599609 11/588483 11/556448 11/593408 11/579944 11/598374 11/603224 11/603804 11/597613 11/604694 11/564588 11/607583 11/566274 11/607874 11/633493 11/608054 11/635874 11/611493 11/611664 11/640154 11/612213 11/643404 11/643144 11/615923 11/644883 11/646718 11/646248 11/646948 11/618453 11/618593 11/618974 11/632594 11/625474 11/657347 11/627219 10/598514 11/659158 11/675378 11/688338 11/785024 11/787144 10/581263 11/787554 11/789503 11/790854 11/744384 11/800914 11/801023 11/801443 11/801823 11/798563 11/798703 11/798704 10/580324 11/756163 11/579194 11/776584 11/779424 11/780253 11/782503 11/578304 PCT/ US07/23179 11/629703 11/236884 11/793184 12/128161 12/129652 12/202171	US-PGPUB	OR	ON	2009/03/05 14:59

S29	100	(11/030998 11/094623 11/181748 10/555054 10/559943 10/565624 11/341464 11/341673 11/276684 11/394263 10/576273 11/430844 11/479373 10/585733 10/585744 11/485334 11/486244 11/487234 10/586543 11/493583 11/494484 11/495653 11/463443 11/463824 11/502094 11/466773 11/513258 11/519754 10/598934 11/521553 11/524244 11/526464 11/526484 10/599609 11/588483 11/556448 11/593408 11/579944 11/598374 11/603224 11/603804 11/597613 11/604694 11/564588 11/607583 11/566274 11/607874 11/633493 11/608054 11/635874 11/611493 11/611664 11/640154 11/612213 11/643404 11/643144 11/615923 11/644883 11/646718 11/646248 11/646948 11/618453 11/618593 11/618974 11/632594 11/625474 11/657347 11/627219 10/598514 11/659158 11/675378 11/688338 11/785024 11/787144 10/581263 11/787554 11/789503 11/790854 11/744384 11/800914 11/801023 11/801443 11/801823 11/798563 11/798703 11/798704 10/580324 11/756163 11/579194 11/776584 11/779424 11/780253 11/782503 11/578304 PCT/ US07/23179 11/629703 11/236884 11/793184 12/128161 12/129652 12/202171).app.	US-PGPUB	OR	ON	2009/03/05 14:59
-----	-----	--	----------	----	----	---------------------

S30	2	(11/030998 11/094623 11/181748 10/555054 10/559943 10/565624 11/341464 11/341673 11/276684 11/394263 10/576273 11/430844 11/479373 10/585733 10/585744 11/485334 11/486244 11/487234 10/586543 11/493583 11/494484 11/495653 11/463443 11/463824 11/502094 11/466773 11/513258 11/519754 10/598934 11/521553 11/524244 11/526464 11/526484 10/599609 11/588483 11/556448 11/593408 11/579944 11/598374 11/603224 11/603804 11/597613 11/604694 11/564588 11/607583 11/566274 11/607874 11/633493 11/608054 11/635874 11/611493 11/611664 11/640154 11/612213 11/643404 11/643144 11/615923 11/644883 11/646718 11/646248 11/646948 11/618453 11/618593 11/618974 11/632594 11/625474 11/657347 11/627219 10/598514 11/659158 11/675378 11/688338 11/785024 11/787144 10/581263 11/787554 11/789503 11/790854 11/744384 11/800914 11/801023 11/801443 11/801823 11/798563 11/798703 11/798704 10/580324 11/756163 11/579194 11/776584 11/779424 11/780253 11/782503 11/578304 PCT/ US07/23179 11/629703 11/236884 11/793184 12/128161 12/129652 12/202171).crtx.	US-PGPUB	OR	ON	2009/03/05 15:00
S31	294	(interpos\$3 with redistribut \$3) and package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:47

S32	169	S31 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:47
S33	7	(interpos\$3 with redistribut\$3 with metal) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:50
S34	40	(interpos\$3 same redistribut\$3 same metal) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:53
S35	33	S34 not S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:54
S36	0	((interpos\$3 near2 metal) with redistributon) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:57
S37	0	((interpos\$3 near5 metal) with redistributon) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:57
S38	0	((interpos\$3 near2 metal) same redistributon) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:57
S39	654	(interpos\$3 near2 metal) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:58
S40	49	(interpos\$3 near2 metal) and package and (stack\$2 near4 (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:59

S41	2893	257/678.ccls. and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/06 11:52
S42	499	S41 and (stack\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/06 11:52
S43	23607	"20030701"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:11
S44	2	"10611390"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:11
S45	2	"6952047".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:12
S46	2	"20040108581"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:14
S47	4	10/611390	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 22:38
S48	2	("20040018661").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 22:50
S49	2	"5422435".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 22:51

S50	3	"20050104209"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 23:10
S51	2	("20050104209").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 23:10
S52	888683	package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S53	1915120	chip die	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S54	168270	S53 near5 (first second)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S55	48831	S52 and S54	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S56	35032	S55 and (substrate PCB PWB)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S57	19549	S56 and ((substrate pcb pwb) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S58	11089	S57 and (adhesive or (die near attach))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38

S59	4140	S58 and ((adhesive or (die near attach)) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S60	2090	S59 and (stack\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S61	413	S60 and ((substrate PCB PWB) near5 (open\$3 window))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S62	189	S61 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S63	35	S62 and (substrate with conductive with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S64	28	S63 and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S65	24	("20020005577" "20020172024" "5291061" "5323060" "5952725" "5998860" "6091140" "6118176" "6258626" "6343019" "6531784" "6650009").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 00:12
S66	85	(redistribution near3 (wafer chip)) and (stack\$2 with (die chip)) and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 00:26
S67	0	S66 and (metal\$3 near3 interposer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 00:42

S68	58	(metal\$3 near3 interposer) and (stack\$2 with (die chip)) and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 00:43
S69	35	(metal\$3 near2 interposer) and (stack\$2 with (die chip)) and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:07
S70	9	Package and (metal\$3 adj interposer) and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:17
S71	18	(metal\$3 with interposer with trace with pad) and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:21
S72	24	("20020005577" "20020172024" "5291061" "5323060" "5952725" "5998860" "6091140" "6118176" "6258626" "6343019" "6531784" "6650009").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:37
S73	2	10/206720	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:41
S74	100	((encapsula\$4 or mold) with liquid with transfer).clm. and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:57
S75	2	("20030197284").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 02:03
S76	0	((encapsula\$4 or mold) with liquid with transfer with lid). clm. and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:11

S77	1	((encapsula\$4 or mold) with liquid with transfer with cover).clm. and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:11
S78	29	((encapsula\$4 or mold) near2 liquid) and ((encapsula\$4 or mold) near2 transfer)).clm. and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:16
S79	0	((interpos\$3 adj metal) with adhesive).clm. and @ad<"20040303"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:54
S80	5	((interpos\$3 adj metal) and adhesive).clm. and @ad<"20040303"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:54
S81	2	("20040178482").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 09:10
S82	2	("20040124539").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 09:12
S83	61	((underfill near4 adhesive) with polymer) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/04/29 19:16
S84	247	("4320438" "4714952" "5012323").PN. OR ("5422435").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2010/11/06 21:11
S85	11	("20020024146" "20040099938" "20040108590" "20040150084" "20040164385" "20060087013" "5422435" "6407456" "6476506" "6621169" "6979905").PN. OR ("7327038").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2010/11/06 21:35

S86	82	("4763188" "5331205" "5332922" "5347429" "5471369" "5483024" "5530292" "5561329" "5646829" "5757080" "5793108" "5804874" "5814881" "5917242").PN. OR ("6118176").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2010/11/06 22:33
S87	48	(interpos\$3 near2 metal) and package and (stack\$2 near4 (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/06 23:17
S88	1	257/E23.169.ccls. and (stack adj die) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/06 23:58
S89	248	257/E23.169.ccls. and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/06 23:58
S90	1	257/E23.169.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:31
S91	0	257/E23.170.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:31
S92	15	257/E23.171.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:31
S93	30	257/E23.172.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:35
S94	0	257/E23.173.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:41
S95	1	257/E23.174.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:42
S96	3	257/E23.175.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:42
S97	1	257/E23.176.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:46

S98	48	257/E23.177.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 12:47
S99	11	257/E23.178.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 13:12
S100	18	257/685.cor. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 13:18
S101	119	257/686.cor. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 13:21
S102	14	257/723.cor. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 14:03
S103	52	257/777.cor. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 14:10
S104	5	257/e25.006.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 14:20
S105	380	257/e25.013.ccls. and (stack adj (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/07 14:21
S106	41	S105 and (wiring adj (chip die substrate))	US-PGPUB; USPAT	OR	ON	2010/11/07 14:23
S107	56	S105 and (interposer)	US-PGPUB; USPAT	OR	ON	2010/11/07 14:31
S108	58	("5291061" "6278613" "6340846" "6441483" "6472758" "6492726" "6563205" "6577013" "6603072" "6730543").PN. OR ("6861288").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2010/11/07 14:40
S109	42	("20020149097" "20040178488" "20040178508" "20050023657" "20050133932" "20060108676" "5128831" "5252857" "5258330" "5518957" "5883426" "5946553" "5986209" "5990566" "6020624" "6020629" "6028365" "6051878" "6072233" "6072236" "6175149"	US-PGPUB; USPAT; USOCR	OR	OFF	2010/11/07 14:46

		"6212767" "6225689" "6235554" "6258623" "6281577" "6294831" "6294839" "6297547" "6303981" "6332766" "6429528" "6548376" "6552910" "6560117" "6607937" "6762488" "6861288").PN. OR ("7557443").URPN.				
S110	2	"6531784".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/11/18 10:02
S111	34	(interpos\$3 near2 metal\$3) and (package with stack) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT	OR	ON	2010/11/18 10:19
S112	1	"20020180023"	DERWENT	OR	OFF	2010/11/18 14:46

11/18/2010 5:57:16 PM

H:\East\Workspaces\10598514.wsp